

1939495-1 Product Details

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1939495-1

TE Internal Number: 1939495-1

 [Active](#)

Memory Sockets

 [Always EU RoHS/ELV Compliant](#) ([Statement of Compliance](#))

Product Highlights:

- Socket Type = Memory Card
- Socket Style = DIMM
- Gold Contact Plating, Mating Area, Material
- 240 Positions
- DRAM Type = Double Data Rate (DDR) II

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Documentation & Additional Information	
Product Drawings: • SOCKET ASSEMBLY DDR-II, SMT, 240P (TIF, Japanese) Catalog Pages/Data Sheets: • None Available Product Specifications: • DDR-II DIMM Socket 240 Positions SMT Type (PDF, Japanese) Application Specifications: • None Available Instruction Sheets: • None Available CAD Files: • None Available	Additional Information: • Product Line Information Additional Product Images: • Module Keying Details Related Products: • Tooling
List all Documents	

Product Features (Please use the Product Drawing for all design activity)	
Product Type Features: • Socket Style = DIMM • Number of Positions = 240 • DRAM Type = Double Data Rate (DDR) II • PCB Mount Style = Surface Mount • Module Orientation = Vertical Electrical Characteristics: • DRAM Voltage = Other Termination Related Features: • Solder Tail Contact Plating = Tin Body Related Features: • Socket Type = Memory Card • Row-to-Row Spacing (mm [in]) = 6.30 [0.248] • Centerline (mm [in]) = 1.00 [0.039] • Number of Rows = Dual • Ejector Type = Standard • Ejector Location = Both Ends • Number of Keys = 1 • Mount Type = Printed Circuit Board	Contact Related Features: • Contact Plating, Mating Area, Material = Gold • Contact Base Material = Copper Alloy Housing Related Features: • Housing Material = Thermoplastic • Housing Flammability Rating = UL 94V-0 Configuration Related Features: • Insertion Style = Direct Insert • Center Key (mm [in]) = None Industry Standards: • RoHS/ELV Compliance = RoHS compliant, ELV compliant • Lead Free Solder Processes = Reflow solder capable to 245°C • RoHS/ELV Compliance History = Always was RoHS compliant Packaging Related Features: • Packaging Method = Tray • Packaging Quantity = 16/Tray Other: • Brand = Tyco Electronics



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